

## **Data sheet**

# SAW duplexer LTE band 25

Part number: B1277

Ordering code: B39202B1277P810

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Version: 2.0

DCN: 80-PA243-474 Rev. A

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#### 1 Application

- Low-loss SAW duplexer for mobile telephone LTE Band 25 (PCS) systems.
- LTE band 25 uplink: 1882.5 MHz (pass band 65 MHz)
- LTE band 25 downlink: 1962.5 MHz (pass band 65 MHz)
- Qualcomm® micro-Acoustic Power Management (MAPM)
- Low insertion attenuation
- Low amplitude ripple
- Usable pass band 65 MHz

#### 2 Features

- Package size 1.8±0.05 mm × 1.4±0.05 mm
- Package height 0.475 mm (max.)
- Approximate weight 3 mg
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 3 (MSL3)

Pin configuration

**3** 

**6** 

8

**2**, 4, 5, 7,

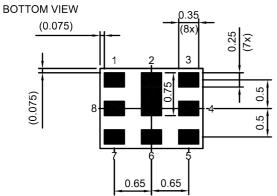
RX

TX **ANT** 

Ground

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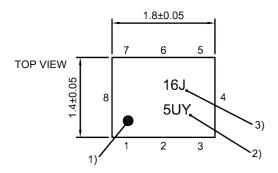
#### 3 **Package**



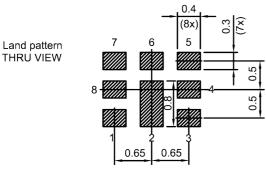
Pad and pitch tolerance ±0.05

#### SIDE VIEW





- 1) Marking for pad number 1
- 2) Example of encoded lot number
- 3) Example of encoded filter type number



Landing pad tolerance -0.02

Figure 1: Drawing of package with package height A = 0.475 mm (max.). See Sec. Package information (p. 23).

### 5 Matching circuit

■  $L_{p6}$  = 5.4 nH

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■  $L_{s3}$  = 3.1 nH

■  $L_{s1}$  = 1.4 nH

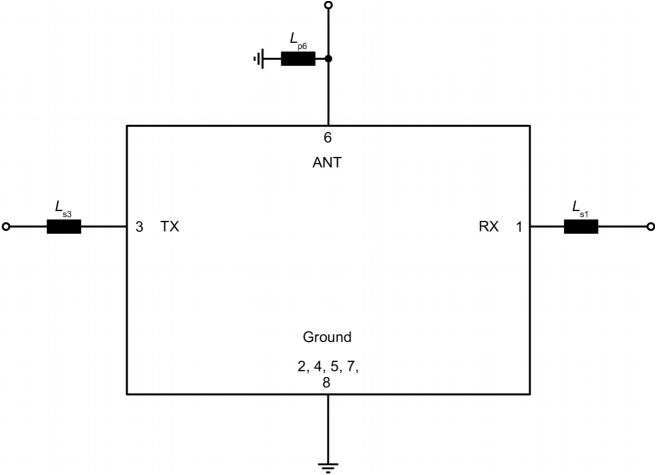


Figure 2: Schematic of matching circuit.

External shunt inductor for ESD protection is recommended at any ports towards antenna.



#### 6 Characteristics

#### 6.1 TX - ANT

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Temperature range for specification  $T_{\rm SPEC} = -30~{\rm ^{\circ}C}~...~+85~{\rm ^{\circ}C}$  TX terminating impedance  $Z_{\rm TX} = 50~\Omega~+3.1~{\rm nH^{1)}}$  ANT terminating impedance  $Z_{\rm ANT} = 50~\Omega~//~5.4~{\rm nH^{1)}}$  RX terminating impedance  $Z_{\rm RX} = 50~\Omega~+1.4~{\rm nH^{1)}}$ 

Characteristics TX – ANT				$\begin{array}{c} \textbf{min.} \\ \textbf{for } T_{\text{SPEC}} \end{array}$	<b>typ.</b> @ +25 °C	$\begin{array}{c} \text{max.} \\ \text{for } T_{\text{\tiny SPEC}} \end{array}$	
Center frequency			f <sub>C</sub>		1882.5	_	MHz
Maximum insertion attenuation			$\alpha_{\text{INT,max}}^{2)}$				
	1850 1910	MHz	iivi,iiax	_	1.1	2.03)	dB
	1850 1910	MHz		_	1.1	2.0	dB
	1850 1915	MHz		_	1.4	2.1 <sup>3)</sup>	dB
	1850 1915	MHz		_	1.4	2.1	dB
Maximum VSWR			VSWR <sub>max</sub>				
@ TX port	1850 1915	MHz	max	_	1.4	2.0	
@ ANT port	1850 1915	MHz		_	1.4	2.0	
Minimum attenuation			$\boldsymbol{\alpha}_{\text{min}}$				
	10 616	MHz		55	60	_	dB
	617 652	MHz		53	59	_	dB
	699 716	MHz		52	58	_	dB
	728 768	MHz		52	56	_	dB
	852 894	MHz		50	54	_	dB
	1166 1187	MHz		46	50	_	dB
	1225 1250	MHz		46	49	_	dB
	1559 1563	MHz		45	50	_	dB
	1565.42 1573.37	MHz		45	50	_	dB
	1573.37 1577.47	MHz		45	50	_	dB
	1577.47 1585.42	MHz		45	50	_	dB
	1597.55 1605.89	MHz		45	51	_	dB
	1930.25 1989.75	MHz		46	58	_	dB
	1930.25 1994.75	MHz		46	58	_	dB
	2110 2200	MHz		44	50	_	dB
	2350 2360	MHz		40	54	_	dB
	2402 2483	MHz		35	53	_	dB
	2496 2690	MHz		28	37	_	dB
	3300 3800	MHz		32	39	_	dB
	3700 3830	MHz		32	42	_	dB
	4900 5950	MHz		35	42	_	dB
	5550 5745	MHz		35	42	_	dB
	7400 7660	MHz		31	35	_	dB

See Sec. Matching circuit (p. 6).

Integrated attenuation  $\alpha_{\text{INT}}$ : Averaged power  $|S_{ii}|^2$  over the center 4.5 MHz of LTE 5 MHz (25 RB) channels.



Valid for typical temperature T = +25 °C.



#### 6.2 ANT - RX

Temperature range for specification  $T_{\rm SPEC} = -30~^{\circ}{\rm C}~...~+85~^{\circ}{\rm C}$  TX terminating impedance  $Z_{\rm TX} = 50~\Omega + 3.1~{\rm nH^{1)}}$  ANT terminating impedance  $Z_{\rm ANT} = 50~\Omega~//~5.4~{\rm nH^{1)}}$  RX terminating impedance  $Z_{\rm RX} = 50~\Omega + 1.4~{\rm nH^{1)}}$ 

Characteristics ANT – RX				$\begin{array}{c} \text{min.} \\ \text{for } T_{\text{SPEC}} \end{array}$	<b>typ.</b> @ +25 °C	$\begin{array}{c} \text{max.} \\ \text{for } T_{\text{SPEC}} \end{array}$	
Center frequency			f <sub>C</sub>	_	1962.5	_	MHz
Maximum insertion attenuation			$\alpha_{\text{INT,max}}^{\qquad 2)}$				
	1930 1990	MHz		_	1.6	2.73)	dB
	1930 1990	MHz		_	1.6	2.7	dB
	1930 1995	MHz		_	1.6	2.73)	dB
	1930 1995	MHz		_	1.6	2.7	dB
Maximum VSWR			$VSWR_{max}$				
@ ANT port	1930 1995	MHz		_	1.6	2.04)	
	1930 1995	MHz		_	1.6	2.1	
@ RX port	1930 1995	MHz		_	1.7	2.04)	
	1930 1995	MHz		_	1.7	2.1	
Minimum attenuation			$\alpha_{_{min}}$				
	10 662	MHz	111111	60	66	_	dB
	80	MHz		65	100	_	dB
	663 698	MHz		60	66	_	dB
	699 862	MHz		58	62	_	dB
	1710.15 1779.85	MHz		58	68	<u> </u>	dB
	1850.25 1909.75	MHz		45	50	_	dB
	1850.25 1914.75	MHz		414)	48	_	dB
	1850.25 1914.75	MHz		37	45	_	dB
	2055 2080	MHz		40	58	_	dB
	2305 2315	MHz		48	67	<u> </u>	dB
	2402 2483	MHz		58	68	<u> </u>	dB
	2496 2690	MHz		38	45	_	dB
	3300 3800	MHz		35	50	_	dB
	3860 3990	MHz		36	51	_	dB
	4900 5950	MHz		42	51	_	dB
	5790 5985	MHz		42	51	_	dB
	7720 7980	MHz		30	43	_	dB

See Sec. Matching circuit (p. 6).

Integrated attenuation  $\alpha_{INT}$ : Averaged power  $|S_{ii}|^2$  over the center 4.5 MHz of LTE 5 MHz (25 RB) channels.

Valid for typical temperature T = +25 °C.

Valid for temperature  $T = +25 \,^{\circ}\text{C...} + 85 \,^{\circ}\text{C.}$ 



#### 6.3 TX - RX

Temperature range for specification  $T_{\rm SPEC} = -30~^{\circ}{\rm C}~...~+85~^{\circ}{\rm C}$  TX terminating impedance  $Z_{\rm TX} = 50~\Omega + 3.1~{\rm nH^{1)}}$  ANT terminating impedance  $Z_{\rm ANT} = 50~\Omega~//~5.4~{\rm nH^{1)}}$  RX terminating impedance  $Z_{\rm RX} = 50~\Omega + 1.4~{\rm nH^{1)}}$ 

Characteristics TX – RX				$\begin{array}{ c c c c c c c c c c c c c c c c c c c$	<b>typ.</b> @ +25 °C	$\begin{array}{c} \text{max.} \\ \text{for } T_{\text{\tiny SPEC}} \end{array}$	
Minimum isolation			α <sub>INT,min</sub> <sup>2)</sup>				
	1850 1910	MHz		52 <sup>3)</sup>	55	_	dB
	1850 1910	MHz		52	55	_	dB
	1850 1915	MHz		52 <sup>3)</sup>	55	_	dB
	1850 1915	MHz		50	55	_	dB
	1930 1990	MHz		57 <sup>4)</sup>	63	_	dB
	1930 1990	MHz		57	63	_	dB
	1930 1995	MHz		57 <sup>4)</sup>	63	_	dB
	1930 1995	MHz		57	63	_	dB

<sup>&</sup>lt;sup>1)</sup> See Sec. Matching circuit (p. 6).

Integrated attenuation  $\alpha_{INT}$ : Averaged power  $|S_{ii}|^2$  over the center 4.5 MHz of LTE 5 MHz (25 RB) channels.

Valid for temperature  $T = +25 \,^{\circ}\text{C...} + 85 \,^{\circ}\text{C.}$ 

<sup>&</sup>lt;sup>4)</sup> Valid for typical temperature T = +25 °C.



#### 7 **Maximum ratings**

Storage temperature	T <sub>STG</sub> <sup>1)</sup> = −40 °C +90 °C	
DC voltage	$ V_{DC} ^{3)} = 0 \text{ V (max.)}^{2)}$	
ESD voltage		
	$V_{ESD}^{4)} = 50 \text{ V (max.)}$	Machine model.
	$V_{\rm ESD}^{5)} = 125  \text{V (max.)}$	Human body model.
	$V_{\rm ESD}^{6)} = 700  \text{V (max.)}$	Charged device model.
Input power @ TX port: 1850.24 1914.76 MHz	P <sub>IN</sub> = 31 dBm	Continuous wave for 5000 h @ 50 °C.

Not valid for packaging material. Storage temperature for packaging material is -25 °C to +40 °C.

<sup>2)</sup> 168h Damp Heat Steady State acc. IEC 60068-2-67 Cy.

<sup>3)</sup> 

In case of applied DC voltage blocking capacitors are mandatory.

According to JESD22-A115B (MM – Machine Model), 10 negative & 10 positive pulses. 4)

According to JESD22-A114F (HBM – Human Body Model), 1 negative & 1 positive pulse.

According to JESD22-C101C (CDM - Field Induced Charged Device Model), 3 negative & 3 positive pulses.



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#### **Transmission coefficients** 8

## 8.1 TX - ANT 0.0 $-\alpha/dB$ 1.0 0.701 2.0 1.61 3.0 4.0 5.0 1880 1900 1920 1840 1860 f/MHz0.0 20.0 40.0 60.0 80.0 <u>+</u> 1750 1800 1850 1900 1950 2000 2050 2100 f/MHz 0.0 20.0 40.0 60.0 80.0 4000 1000 2000 3000 5000 6000

Figure 3: Attenuation TX – ANT.

f/MHz

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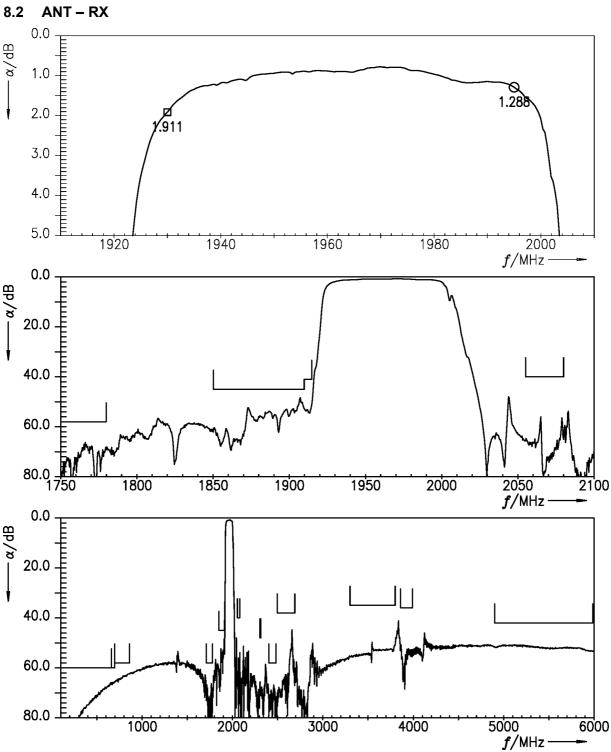


Figure 4: Attenuation ANT – RX.

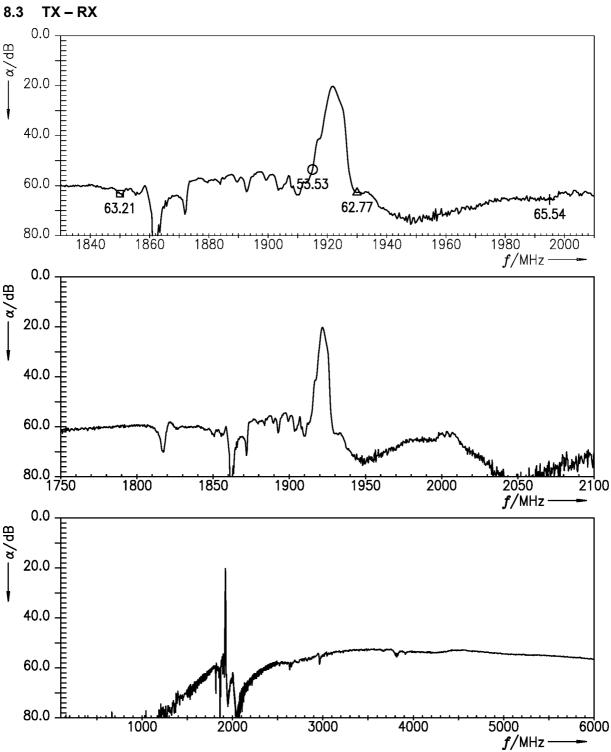
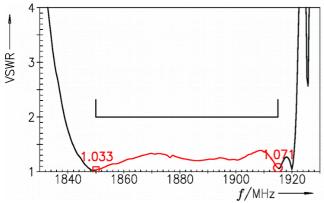


Figure 5: Isolation TX – RX.

#### 9 Reflection coefficients



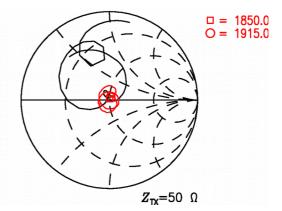
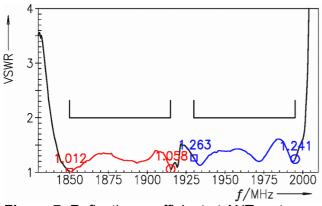


Figure 6: Reflection coefficient at TX port.



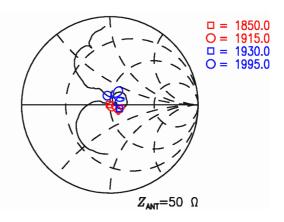
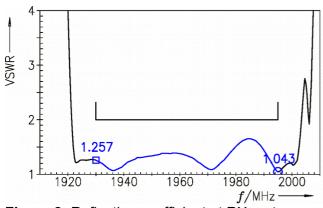


Figure 7: Reflection coefficient at ANT port.



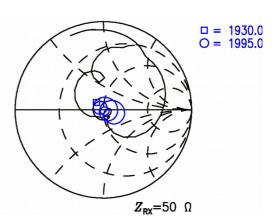


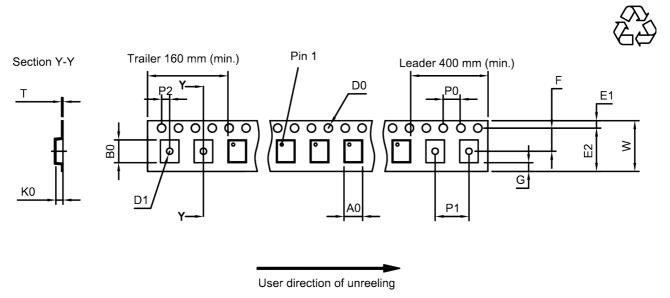
Figure 8: Reflection coefficient at RX port.



## 10 Packing material

### 10.1 Tape

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**Figure 9:** Drawing of tape (first-angle projection) for illustration only and not to scale. The valid tape dimensions are listed in Table 1.

A <sub>0</sub>	1.6±0.05 mm	-	E <sub>2</sub>	6.25 mm (min.)	_	P <sub>1</sub>	4.0±0.1 mm
B <sub>0</sub>	2.0±0.05 mm		F	3.5±0.05 mm	_	$P_2$	2.0±0.05 mm
D <sub>0</sub>	1.5+0.1/-0 mm		G	0.75 mm (min.)	_	Т	0.25±0.03 mm
D <sub>1</sub>	0.8+0.1/-0 mm		K <sub>0</sub>	0.64±0.05 mm		W	8.0+0.3/-0.1 mm
E <sub>1</sub>	1.75±0.1 mm		P <sub>0</sub>	4.0±0.1 mm	·		

Table 1: Tape dimensions.

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#### 10.2 Reel with diameter of 180 mm

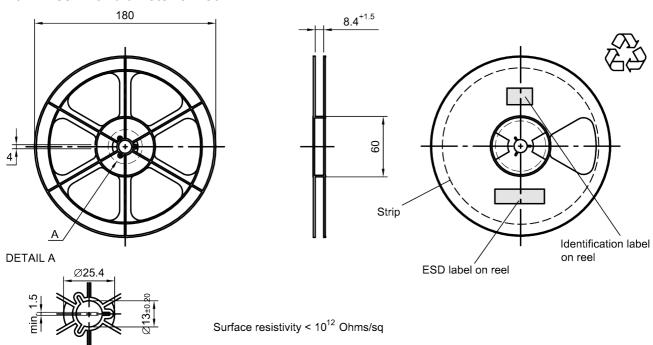


Figure 10: Drawing of reel (first-angle projection) with diameter of 180 mm.

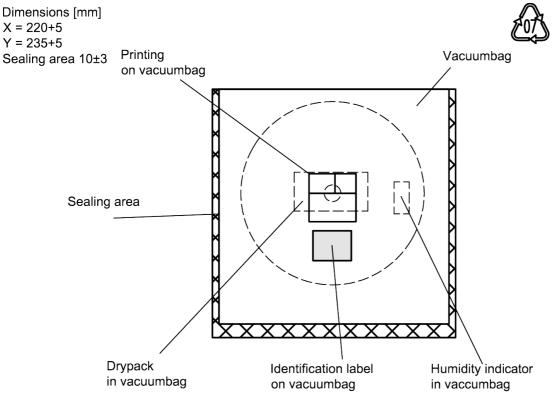


Figure 11: Drawing of moisture barrier bag (MBB) for reel with diameter of 180 mm.

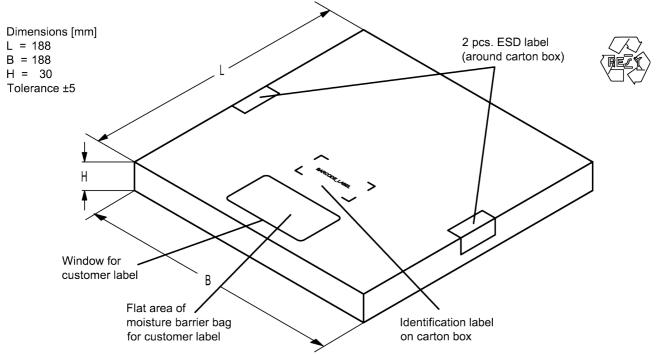


Figure 12: Drawing of folding box for reel with diameter of 180 mm.

#### 10.3 Reel with diameter of 330 mm

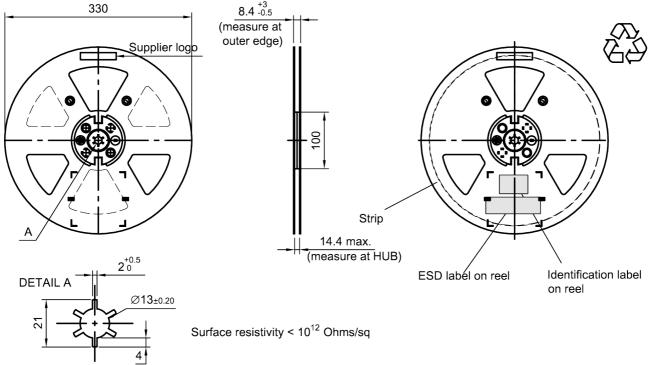


Figure 13: Drawing of reel (first-angle projection) with diameter of 330 mm.



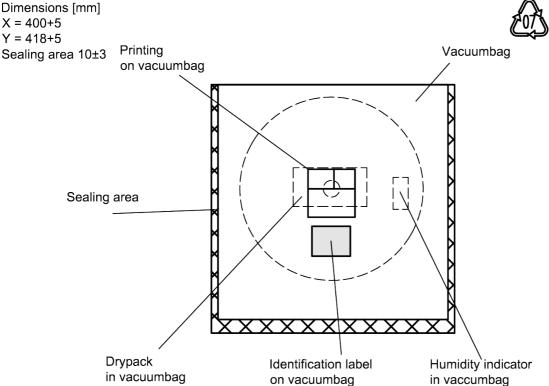


Figure 14: Drawing of moisture barrier bag (MBB) for reel with diameter of 330 mm.

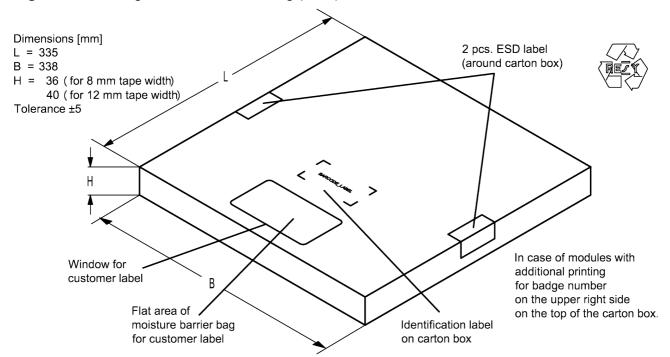


Figure 15: Drawing of folding box for reel with diameter of 330 mm.



#### 11 Marking

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Products are marked with product type number and lot number encoded according to Table 2:

### ■ Type number:

The 4 digit type number of the ordering code, e.g., B3xxxxB1234xxxx, is encoded by a special BASE32 code into a 3 digit marking.

Example of decoding type number marking on device in decimal code.

**16J** 1234 1 x  $32^2$  + 6 x  $32^1$  + 18 (=J) x  $32^0$ 1234

The BASE32 code for product type B1277 is 17X.

#### ■ Lot number:

The last 5 digits of the lot number, 12345, are encoded based on a special BASE47 code into a 3 digit marking.

Example of decoding lot number marking on device in decimal code.

12345 =>

 $5 \times 47^2 + 27 (=U) \times 47^1 + 31 (=Y) \times 47^0$ 12345

Adopted BASE32 code for type number						
Decimal	Base32	Decimal	Base32			
value	code	value	code			
0	0	16	G			
1	1	17	Н			
2	2	18	J			
3	3	19	K			
4	4	20	M			
5	5	21	N			
6	6	22	Р			
7	7	23	Q			
8	8	24	R			
9	9	25	S			
10	Α	26	Т			
11	В	27	V			
12	С	28	W			
13	D	29	X			
14	E	30	Υ			
15	F	31	Z			

Adopted BASE47 code for lot number					
Decimal	Base47	Decimal	Base47		
value	code	value	code		
0	0	24	R		
1	1	25	S		
2	2	26	T		
3	3	27	U		
4	4	28	V		
5	5	29	W		
6	6	30	X		
7	7	31	Y		
8	8	32	Z		
9	9	33	b		
10	Α	34	d		
11	В	35	f		
12	С	36	h		
13	D	37	n		
14	E	38	r		
15	F	39	t		
16	G	40	V		
17	Н	41	\		
18	J	42	?		
19	K	43	{		
20	L	44	}		
21	M	45	<		
22	N	46	>		
23	Р				

**Table 2:** Lists for encoding and decoding of marking.

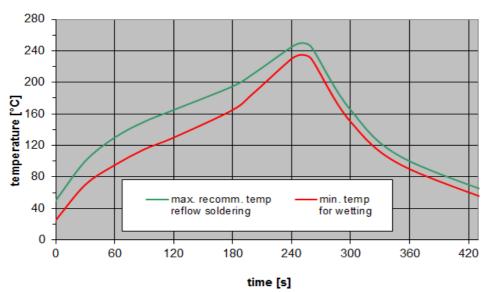


### 12 Soldering profile

The recommended soldering process is in accordance with IEC  $60068-2-58-3^{rd}$  edit and IPC/JEDEC J-STD-020B.

ramp rate	≤ 3 K/s
preheat	125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
T > 220 °C	30 s to 70 s
T > 230 °C	min. 10 s
T > 245 °C	max. 20 s
<i>T</i> ≥ 255 °C	-
peak temperature $T_{peak}$	250 °C +0/-5 °C
wetting temperature $T_{min}$	230 °C +5/-0 °C for 10 s ± 1 s
cooling rate	≤ 3 K/s
soldering temperature <i>T</i>	measured at solder pads

Table 3: Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).



**Figure 16:** Recommended reflow profile for convection and infrared soldering – lead-free solder.



#### 13 Annotations

#### 13.1 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

#### 13.2 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local RF360 sales office.

### 13.3 Ordering codes and packing units

Ordering code	Packing unit
B39202B1277P810	15000 pcs
B39202B1277P810S 5	5000 pcs

Table 4: Ordering codes and packing units.



#### 14 Cautions and warnings

#### 14.1 Display of ordering codes for RF360 products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of RF360, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under <a href="https://rffe.gualcomm.com/">https://rffe.gualcomm.com/</a>.

#### 14.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

For information on recycling of tapes and reels please contact one of our sales offices.

#### 14.3 Moldability

Before using in overmolding environment, please contact your local RF360 sales office.

#### 14.4 Package information

#### Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on RF360 internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of RF360, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

#### **Dimensions**

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

#### **Projection method**

Unless otherwise specified first-angle projection is applied.



#### 15 Important notes

The following applies to all products named in this publication:

- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule, RF360 Europe GmbH and its affiliates are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an RF360 product with the properties described in the product specification is suitable for use in a particular customer application.
- 2. We also point out that in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
- 3. The warnings, cautions and product-specific notes must be observed.
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